

# E4M0045075J2

Silicon Carbide Power MOSFET E-Series Automotive N-Channel Enhancement Mode

### **Features**

- 750V SiC MOSFET technology
- Optimized package with separate driver source pin
- 4.7mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q<sub>rr</sub>)
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

### Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

# **Typical Applications**

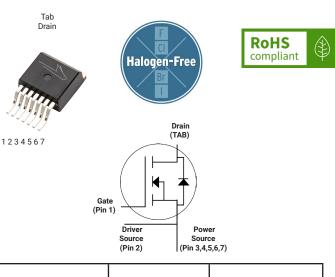
- Motor Control
- EV On Board Battery Chargers (OBC)
- Automotive DC/DC Converters for EV/HEV

### Maximum Ratings (T<sub>c</sub> = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Note	
V <sub>DSmax</sub>	Drain - Source Voltage		750	V	
V <sub>GSmax</sub>	Gate - Source Voltage		-8/+19	V	Note: 1
		T <sub>C</sub> = 25°C	46		Fig. 19
ID	Continuous Drain Current, $V_{GS} = 15 \text{ V}$ T <sub>C</sub> = 100°C		34	A	Note: 2
I <sub>D(pulse)</sub>	Pulsed Drain Current, Pulse width $t_{\rm P}$ limited by $T_{\rm jmax}$		132	А	Fig. 22
P <sub>D</sub>	Power Dissipation, $T_c = 25^{\circ}C$ , $T_J = 175^{\circ}C$		172	W	Fig. 20 Note: 2
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Storage Temperature			°C	
TL	Solder Temperature, 1.6mm (0.063") from case for 10s		260	°C	

Note (1): Recommended turn off / turn on gate voltage V\_{\_{GSop}} - 4V...0V / +15V Note (2): Verified by design

# Package



Part Number	Package	Marking
E4M0045075J2	TO-263-7XL	E4M0045075J2

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note	
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	750			V	$V_{GS}$ = 0 V, I <sub>D</sub> = 100 µA		
		1.8	2.6	3.8	V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 4.84 mA		
$V_{\text{GS(th)}}$	Gate Threshold Voltage		2.2		V	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 4.84 mA, T <sub>J</sub> = 175°C	Fig. 11	
IDSS	Zero Gate Voltage Drain Current		1	50	μA	V <sub>DS</sub> = 750 V, V <sub>GS</sub> = 0 V		
I <sub>GSS</sub>	Gate-Source Leakage Current		10	250	nA	V <sub>GS</sub> = 15 V, V <sub>DS</sub> = 0 V		
D	Drain-Source On-State Resistance		45	60	mΩ	V <sub>GS</sub> = 15 V, I <sub>D</sub> = 17.6 A	Fig. 4	
R <sub>DS(on)</sub>			68		mΩ	V <sub>GS</sub> = 15 V, I <sub>D</sub> = 17.6 A, T <sub>J</sub> = 175°C	5, 6	
a	Transconductance		12.6		s	V <sub>DS</sub> = 20 V, I <sub>DS</sub> = 17.6 A		
<b>g</b> <sub>fs</sub>			13.1		3	V <sub>DS</sub> = 20 V, I <sub>DS</sub> = 17.6 A, T <sub>J</sub> = 175°C	Fig. 7	
$C_{\text{iss}}$	Input Capacitance		1606			V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 500 V	Fig. 17, 18	
$C_{\text{oss}}$	Output Capacitance		95		pF	f = 1 MHz		
$C_{rss}$	Reverse Transfer Capacitance		8			V <sub>AC</sub> = 25 mV		
E <sub>oss</sub>	Coss Stored Energy		16		μJ	V <sub>DS</sub> = 500 V, f = 1 MHz	Fig. 16	
$C_{o(er)}$	Effective Output Capacitance (Energy Related)		118		pF		Note: 3	
C <sub>o(tr)</sub>	Effective Output Capacitance (Time Related)		165		pF	$V_{GS} = 0 V, V_{DS} = 0 to 500V$		
Eon	Turn-On Switching Energy (Body Diode FWD)		73			$V_{DS}$ = 500 V, $V_{GS}$ = -4 V/15 V, $I_{D}$ = 17.6 A,	Eig 26	
EOFF	Turn-Off Switching Energy (Body Diode FWD)		13		μJ	$R_{G(ext)}$ = 2.5 Ω, L= 99 μH, T <sub>J</sub> = 25°C FWD = Internal Body Diode	Fig. 26, 28	
t <sub>d(on)</sub>	Turn-On Delay Time		8					
tr	Rise Time		11		]	$V_{DD}$ = 500 V, $V_{GS}$ = -4 V/15 V, $I_D$ = 17.6 A, $R_{G(ext)}$ = 2.5 $\Omega$ , L= 99 $\mu$ H, T <sub>J</sub> = 25°C	Fig. 27	
$t_{\text{d(off)}}$	Turn-Off Delay Time		19		ns	Timing relative to V <sub>DS</sub>	28	
t <sub>f</sub>	Fall Time		7					
$R_{G(int)}$	Internal Gate Resistance		3.0		Ω	f = 1 MHz, V <sub>AC</sub> = 25 mV		
$Q_{gs}$	Gate to Source Charge		20		V <sub>DS</sub> = 500 V, V <sub>GS</sub> = -4 V/15 V			
$\mathbf{Q}_{gd}$	Gate to Drain Charge		20		nC	I <sub>D</sub> = 17.6 A	Fig. 12	
Qg	Total Gate Charge		62			Per IEC60747-8-4 pg 21		

# **Flectrical Characteristics** ( $T = 25^{\circ}$ C unless otherwise specified)

Note (3): Co(er), a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 500V Co(tr), a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 500V



# **Reverse Diode Characteristics** ( $T_c = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
		4.8		V	$V_{_{\rm GS}}$ = -4 V, I $_{_{\rm SD}}$ = 8.8 A, T $_{_{\rm J}}$ = 25 °C	Fig. 8,
V <sub>SD</sub>	Diode Forward Voltage	4.2		V	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 8.8 A, T <sub>J</sub> = 175 °C	9, 10
ls	Continuous Diode Forward Current		29	А	$V_{_{GS}} = -4 \text{ V}, \text{ T}_{c} = 25^{\circ}\text{C}$	
I <sub>S, pulse</sub>	Diode pulse Current		132	A	$V_{_{\rm GS}}$ = -4 V, pulse width $t_{\rm p}$ limited by $T_{jmax}$	
t <sub>rr</sub>	Reverse Recover time	11		ns		
Q <sub>rr</sub>	Reverse Recovery Charge	184		nC	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 17.6 A, V <sub>R</sub> = 500 V di <sub>F</sub> /dt = 5485 A/μs, T <sub>J</sub> = 25 °C	
l rrm	Peak Reverse Recovery Current	37		А		
t <sub>rr</sub>	Reverse Recover time	14		ns		
Q <sub>rr</sub>	Reverse Recovery Charge	91		nC	V <sub>GS</sub> = -4 V, I <sub>SD</sub> = 17.6 A, V <sub>R</sub> = 500 V di <sub>F</sub> /dt = 1555 A/µs, T <sub>J</sub> = 25 °C	
I <sub>rrm</sub>	Peak Reverse Recovery Current	12		А		

### **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
R <sub>θJC</sub>	Thermal Resistance from Junction to Case	0.67	0.87	°C/W		Fig. 21

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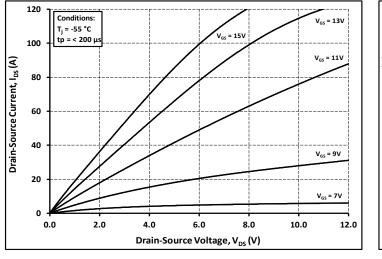


Figure 1. Output Characteristics T<sub>J</sub> = -55 °C

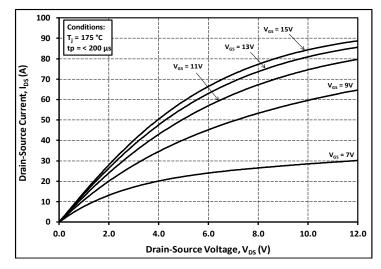
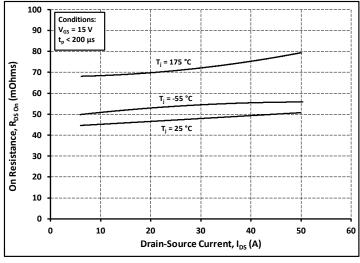
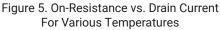
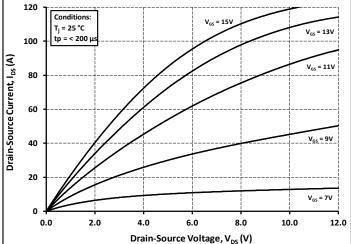


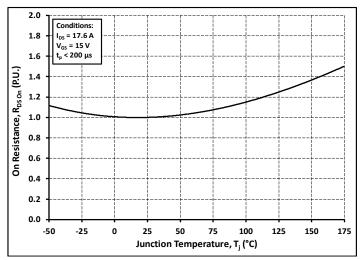
Figure 3. Output Characteristics T<sub>J</sub> = 175 °C



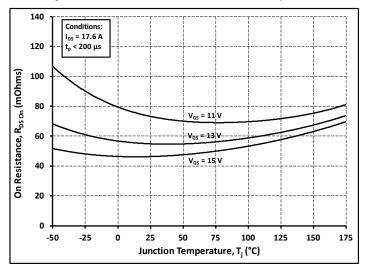


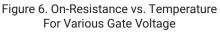






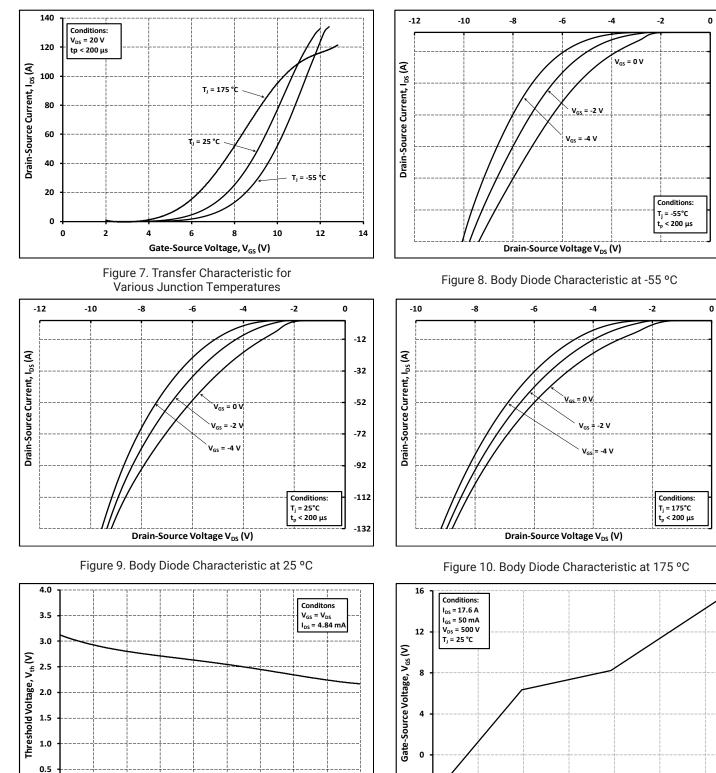






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Junction Temperature T<sub>J</sub> (°C)

50

75

100

125

Figure 12. Gate Charge Characteristics

30

Gate Charge, Q<sub>G</sub> (nC)

40

50

60

-12

-32

-52

-72

-92

-112

-132

-12

-32

-52

-72

-92

-112

-132

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0.0

-50

-25

0

25

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150

175

-4

0

10

Figure 11. Threshold Voltage vs. Temperature

# E4M0045075J2

### **Typical Performance**

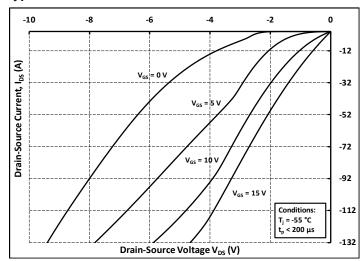


Figure 13. 3rd Quadrant Characteristic at -55 °C

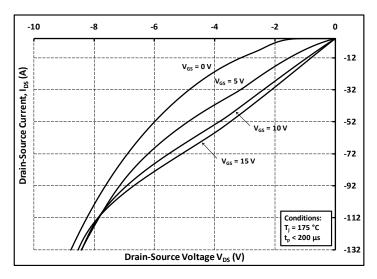
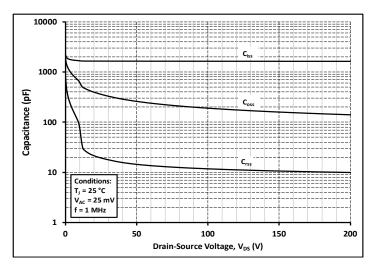
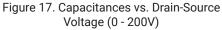


Figure 15. 3rd Quadrant Characteristic at 175 °C





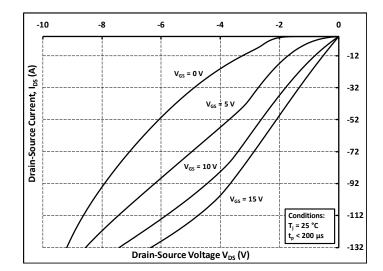


Figure 14. 3rd Quadrant Characteristic at 25 °C

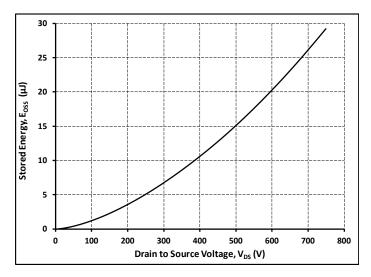


Figure 16. Output Capacitor Stored Energy

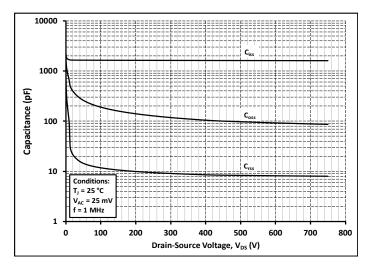
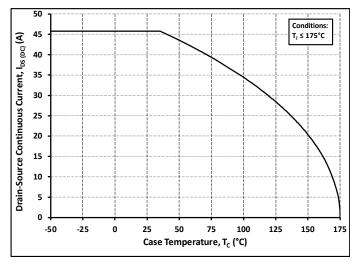


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 750V)

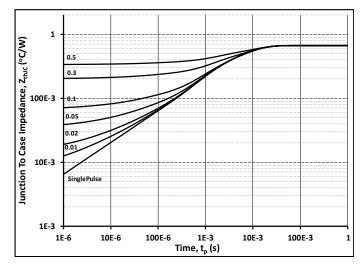
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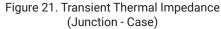
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### **Typical Performance**









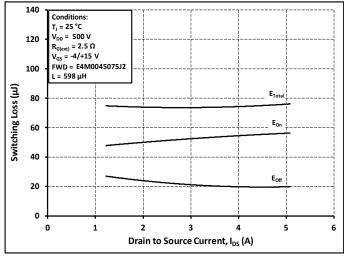


Figure 23. Clamped Inductive Switching Energy vs. Low Drain Current ( $V_{DD}$  = 500V)

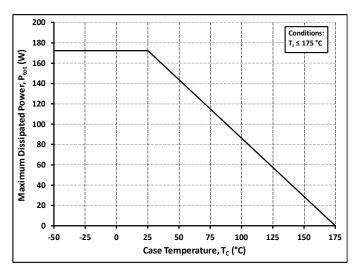
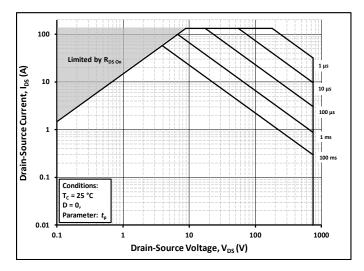
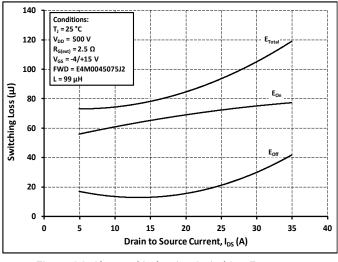
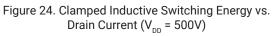


Figure 20. Maximum Power Dissipation Derating vs. Case Temperature









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# **Typical Performance**

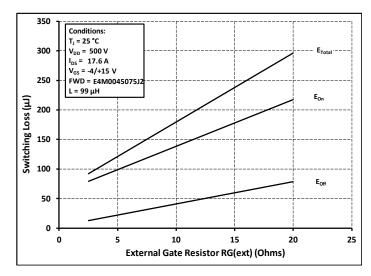


Figure 25. Clamped Inductive Switching Energy vs.  $R_{G(ext)}$ 

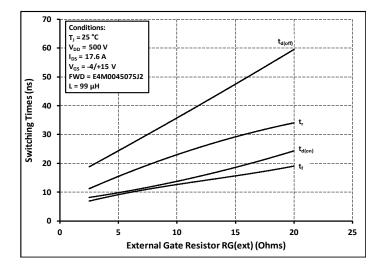


Figure 27. Switching Times vs.  $R_{G(ext)}$ 

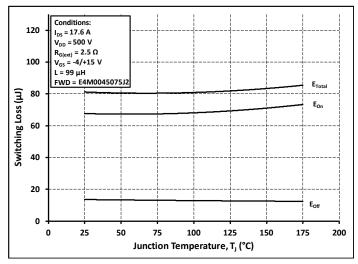


Figure 26. Clamped Inductive Switching Energy vs. Temperature

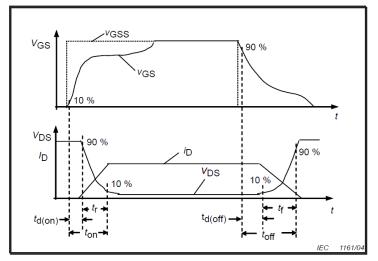


Figure 28. Switching Times Definition

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# **Test Circuit Schematic**

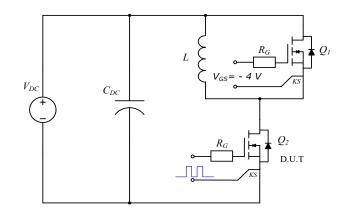
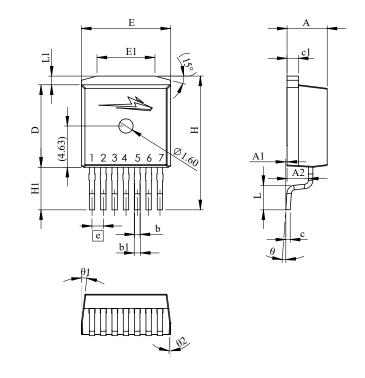


Figure 29. Clamped Inductive Switching Waveform Test Circuit

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# Package Dimensions



	E2	
DI	8	
D2		J

SYMBOL	MIN (mm)	MAX (mm)	
A	4.30	4.70	
A1	0.00	0.25	
A2	2.20	2.60	
b	0.52	0.72	
b1	0.60	0.80	
с	0.42	0.62	
c1	1.07	1.47	
D	9.05	9.45	
D1	7.58	7.98	
D2	2.05	2.45	
Е	9.80	10.20	
E1	6.30	6.97	
E2	7.80	8.20	
e	1.27 I	BSC	
Н	14.87	15.27	
H1	4.55	4.95	
L	2.48	2.88	
L1	0.87	1.27	
θ	0°	8°	
θ1	4°	10°	
θ2	0°	6°	

1	GATE			
2	KELVIN			
3				
4				
5	SOURCE			
6				
7				
8	DRAIN			

NOTE

1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.

2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.

3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.

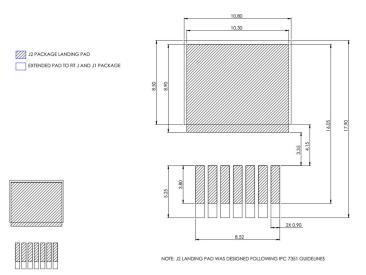
4. PACKAGE BURR FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS

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# Recommended Solder Pad Layout

All dimensions in mm



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# **Revision history**

Document Version	Date of release	Descriptiion of changes
1.0	January 2024	Initial release
2	January - 2025	Legal Disclaimer Updated

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